	Channe	l PowerTrench	[®] MOSFET	M	arch 2015
40V, 50A, Features	8.5 m Ω		General Description	on	
Max $r_{DS(on)}$ = 8.5m Ω at V_{GS} = 10V, I_D = 14A Max $r_{DS(on)}$ = 11.0m Ω at V_{GS} = 4.5V, I_D = 11A Fast Switching			This N-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench [®] technology to deliver low r _{DS(on)} and optimized BV _{DSS} capability to offe superior performance benefit in the application.		
■ RoHS Comp			Applications Inverter Power Supplies 		
	G	D	G _O		
	ד)	D-PAK O-252) Ratings T _c = 25°C unless oth	erwise noted	o s	
Symbol	(T Maximum ∣	[−] O-252) Ratings _{TC} = 25°C unless oth Parameter	erwise noted	Ratings	Units
Symbol V _{DS}	(T Maximum Drain to Sourc	O - 252) Ratings T _C = 25°C unless oth Parameter e Voltage	erwise noted	40	V
Symbol V _{DS}	(T Maximum Drain to Source Gate to Source	O -252) Ratings T _C = 25°C unless oth Parameter e Voltage voltage		40 ±20	
Symbol V _{DS}	(T Maximum Drain to Source Gate to Source	CO-252) Ratings T _C = 25°C unless oth Parameter e Voltage e Voltage -Continuous (Package limited)	T _C = 25°C	40 ±20 50	V
	(T Maximum Drain to Source Gate to Source	CO-252) Ratings T _C = 25°C unless oth Parameter e Voltage -Continuous (Package limited) -Continuous (Silicon limited)	T _C = 25°C T _C = 25°C	40 ±20 50 57	V
Symbol V _{DS} V _{GS}	(T Maximum Drain to Source Gate to Source	CO-252) Ratings T _C = 25°C unless oth Parameter e Voltage - Continuous (Package limited) - Continuous (Silicon limited) - Continuous	T _C = 25°C	40 ±20 50 57 15.2	V V
Symbol V _{DS} V _{GS}	(T Maximum Drain to Source Gate to Source	CO-252) Ratings T _C = 25°C unless oth Parameter e Voltage -Continuous (Package limited) -Continuous (Silicon limited) -Continuous -Pulsed	T _C = 25°C T _C = 25°C	40 ±20 50 57	V V

Operating and Storage Junction Temperature Range

Thermal Characteristics

 E_{AS}

 P_D

T_J, T_{STG}

$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.8	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a) 40	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient (Note 1)) 96	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8447L	FDD8447L	D-PAK(TO-252)	13"	16mm	2500 units

mJ

W

°C

153

44

3.1

1.3

-55 to +150

FDD8447L 40V N-Channel PowerTrench[®] MOSFET

FDD8447L 40
V N-Channel
PowerTrench [®]
MOSFET

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V	
ΔΒV _{DSS} ΔΤ _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		35		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32V, V _{GS} = 0V			1	μA	
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20V, V_{GS} = 0V			±100	nA	
On Chara	cteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.9	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to $25^{\circ}C$		-5		mV/°C	
		V _{GS} = 10V, I _D = 14A		7.0	8.5		
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 4.5V, I _D = 11A		8.5	11.0	mΩ	
		V _{GS} = 10V, I _D = 14A, T _J =125°C		10.4	14.0		
9 _{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 14A		58		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance	t Capacitance		1970		pF	
C _{oss}	Output Capacitance	− V _{DS} = 20V, V _{GS} = 0V, − f = 1MHz		250		pF	
C _{rss}	Reverse Transfer Capacitance			150		pF	
R _g	Gate Resistance	f = 1MHz		1.27		Ω	
Switching	Characteristics						
t _{d(on)}	Turn-On Delay Time			12	21	ns	
<u>u(0.1)</u> t _r	Rise Time	$V_{DD} = 20V, I_D = 1A$		12	21	ns	
t _{d(off)}	Turn-Off Delay Time	$-V_{GS}$ = 10V, R_{GEN} = 6 Ω		38	61	ns	
t _f	Fall Time	-		9	18	ns	
Q _{g(TOT)}	Total Gate Charge, V _{GS} = 10V			37	52	nC	
Q _{a(TOT)}	Total Gate Charge, V _{GS} = 5V	$V_{DD} = 20V, I_D = 14A$		20	28	nC	
Q _{gs}	Gate to Source Gate Charge	– V _{GS} = 10V		6		nC	
Q _{gd}	Gate to Drain "Miller" Charge			7		nC	
Drain-Sou	urce Diode Characteristics						
	Maximum Continuous Drain-Source Diode	Forward Current (Note 1a)			2.6	Α	
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 14A$ (Note 2)		0.8	1.2	V	
t _{rr}	Reverse Recovery Time			22		ns	
Q _{rr}	Reverse Recovery Charge	— I _F = 14A, di/dt = 100A/μs		11		nC	

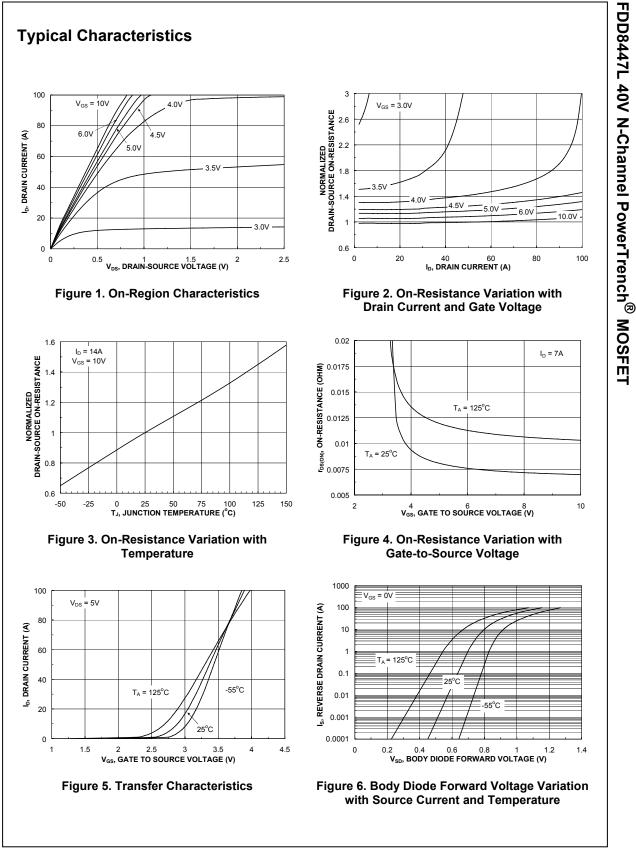
1: R_{0JA} is the sum of the junction-to-case and case-to- ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0JA} is determined by the user's board design.

a. 40°C/W when mounted on a 1 in2 pad of 2 oz copper

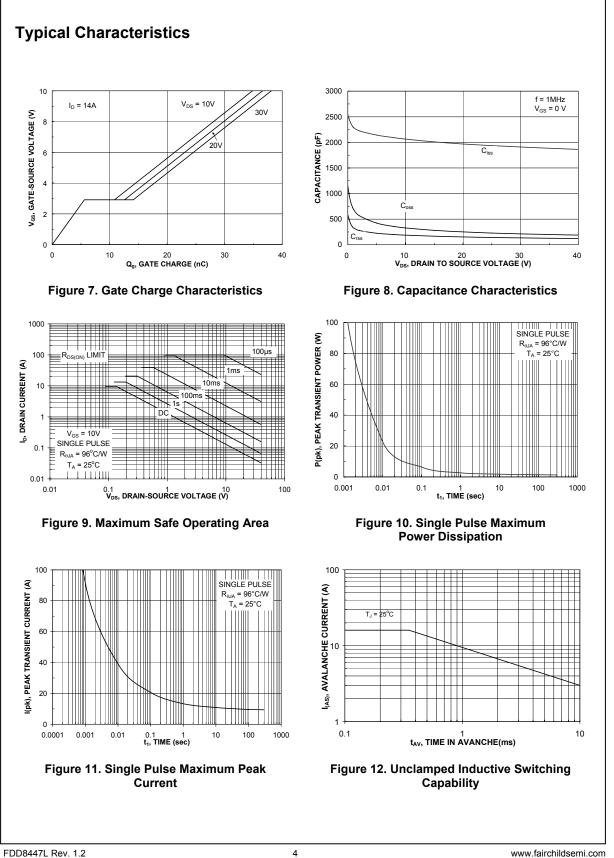
b. 96°C/W when mounted on $\,$ a minimum pad.

2: Pulse Test: Pulse Width < 300μ s, Duty cycle < 2.0%.

3: Starting TJ = 25⁰C, L = 1mH, IAS = 17.5A, VDD = 40V, VGS = 10V.

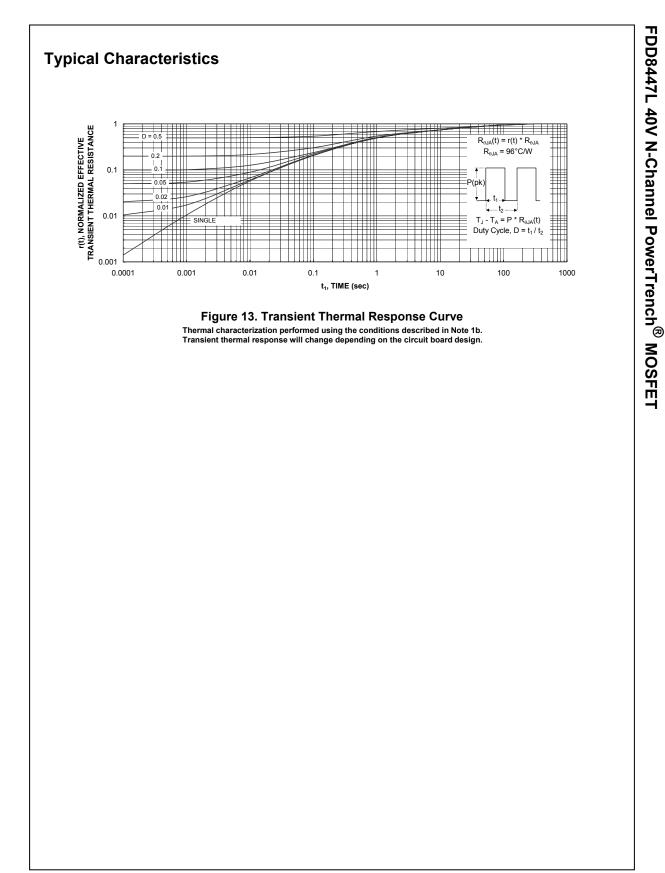


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